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PATENT APPLICATION  
Docket No. 11675.163.2

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

*S/A Amdt.  
1-7-03  
R. J. J. J.*

In re application of:

Terry N. Williams

Serial No.: 09/761,375

) Art Unit  
) 2882

Filed: January 16, 2001

For: BUFFERED RESIST PROFILE ETCH OF A  
FIELD EMISSION DEVICE STRUCTURE

Examiner: Jurie Yun

Confirmation No.: 5328

AMENDMENT AND RESPONSE

Commissioner for Patents  
Washington, D. C. 20231

Sir:

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DEC 20 2002  
TECHNOLOGY CENTER 2800

In response to the Office Action mailed from the United States Patent and Trademark Office on August 2, 2002, please enter the following amendments and remarks into the file of the above-identified application.